# Update on cooling and mechanics of the luminosity detector

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### Overview



- status of the cooling system
- update on mechanical structure

# Cooling system: General setup





	sensors	LDO Voltage	resistance in	Multiplexer
		regulator	flexcables	etc.
worst case	1120 W	320W	160W	$\sim \! 100 W$
likely case	370 W	110W	20W	$\sim \! 100 W$

- Total estimated heat load per half detector:  ${\sim}1~\text{kW}\sim\!350~\text{W}$
- For cooling test: copper dummys and high power resistors

## Half detector prototype



- production of halfplanes is finished
- First full half detector under preparation for cooling test
- First test in vacuum seems ok

## Cooling test preparation



- PT100 sensors glued to half planes and copper dummies
- Resistors glued to copper dummies and connected
- Busbars prepared for installation

## Mechanical setup: Beampipe installation





Three options for installing the inner beampipe:

- Glue everything outside, install everything at once
- Glue cone outside, connect cone and metal part in the box
- Install metal part, glue everything in the box.

All tricky.....

# Summary and outlook

- production of half planes finished
- half plane prototype successfully tested
- new design vacuum box produced, first tests successful

What is next:

- extended test of new vacuum box
- test of half detector prototype
- extended cooling test
- production of final detector

# Aluminum steel contact after cooling

after cutting:





#### after cooling to $-40^{\circ}$ C:





No gap between the materials, very good contact

## Comparison of materials and processes









## Test of the aluminum-diamond contact



- Setup with copper dummy
- Comparison of FEM results with measurements
- Test and comparison of several contact materials

## FEM-simulation and measurement



- Simulated temperature difference  $\sim 55^\circ C$
- Measured temperature difference (two Pt100): 50°C
- High radial temperature gradient (up to  $2\frac{K}{mm}$ )

Graphitfolie PC93  $\sim 0.88 \frac{^{\circ}C}{W} \sim 0.72 \frac{^{\circ}C}{W}$ kein Material H. Leithoff

## Contact materials



H. Leithoff (HIM)

## Contact materials 2



Upper limit for the material transition temperature rise:



## Temperature Gradient



- Temperature gradient varies on the diamond
- High values near the cooling structure (> 1.5  $\frac{K}{mm}$ )
- interesting measurements are in region with > 1  $\frac{K}{mm}$

## Melting aluminum around stainless steel pipes



- Casting mould with stop off and cooling pipe
- The pipe can move in one direction to minimize internal stress

# Casting mould after first melting process



- First test done under vacuum
- good results, but the vacuum furnace gets really dirty